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Electro- and photochemical studies of gold (III) bromide towards a novel laser-based method of gold patterning

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Abstract

In this report, we demonstrate a novel technique for the microscopic patterning of gold by combining the photoreduction of $Au^{II}Br_4^-$ to $Au^IBr_2^-$ and the electrochemical reduction of $Au^IBr_2^-$ to elemental gold in a single step within solution. While mask-based methods have been the norm for electroplating, the adoption of direct laser writing for flexible, real-time patterning has not been widespread. Through irradiation using a 405 nm laser and applying a voltage corresponding to a selective potential window specific to $Au^IBr_2^-$, we have shown that we can locally deposit elemental gold at the focal point of the laser. In addition to demonstrating the feasibility of the technique, we have collected data on the kinetics of the photoreduction reaction in ethanol and have deduced its rate law. We have confirmed the selective deposition of $Au^IBr_2^-$ within a potential window through controlled potential electrolysis experiments and through direct measurement on a quartz crystal microbalance. Finally, we have verified local deposition through scanning electron microscopy.

Keywords: photolithography, direct laser writing, electrodeposition, gold (III) bromide, photoreduction

1. Introduction

Due to the excellent electrical and electrochemical properties of gold and its use in sensors, actuators, and circuits the development of new lithographic methods for patterning is a continually evolving field of research [1–4]. The primary method for patterning metal follows a two-step process: (a) a patterning step to define where the metal will be placed and (b) a

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growth step to deposit the metal. These are usually done by photo- or e-beam-lithography, followed by thermal deposition or electroplating. Electroless deposition of coinage metals is also common when depositing onto nonconductive surfaces [5–10]. Alternative methods that use a single step to directly pattern the metal offer distinct advantages over mask-based methods. Many of these single step methods use a focused laser, such as: vapor phase deposition [11], photoreduction of metal-organic frameworks [12] and simultaneous two-photon polymerization and photoreduction [13, 14]. Some of these direct laser writing (DLW) methods rely on a combination of photochemical excitation and thermal excitation to nucleate metal nanoparticles which then grow and join together. One issue with photoreduced metals is that, because of the use of organic reducing agents and the nucleation mechanism

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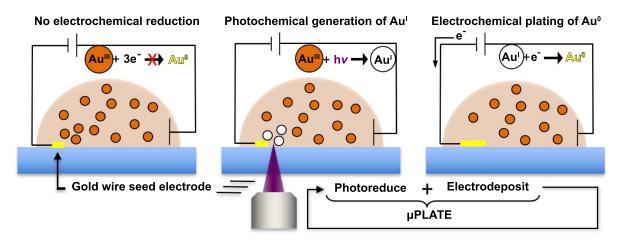


Figure 1. μ PLATE process. (Left) A Au^{III}Br₄⁻ solution with a gold working electrode is at a potential that does not plate Au^{III}Br₄⁻. (Middle) Irradiation of the solution with a 405 nm laser focused near the electrode causes the reduction of Au^{III}Br₄⁻ to Au^IBr₂⁻. (Right) Localized electrodeposition of Au^{II}Br₂⁻ to Au⁰ takes place onto the working electrode.

[15], they tend to have lower conductivity than electroplated or vapor deposited patterns [16–21]. While electroplating and vapor deposition produce high-quality metal features, patterns are reliant on pre-fabricated masks and, thus, cannot match the flexibility of DLW. Laser exposure can be coupled to electroplating as a patterning technique and has been demonstrated in several different ways. In one method the laser is used to thermally enhance the patterning [22, 23] while in another the laser is used to remove a protective oxide coating [24]. Au nanoparticles have also been assembled using a combination of electrophoresis and laser trapping to create microstructures [25, 26] as well as laser sintering [27–31]. Gold has also been patterned on graphene using photo-induced electronhole formation to locally reduce gold from solution [32].

The method described below, which we call: microscale photochemical laser traced electrodeposition, or μ PLATE, couples the processes of photoreduction and electroplating into a single patterning step. Briefly, the μ PLATE method uses a focused laser to locally convert Au^{II} in solution to Au^I and subsequently electroplate the Au^I to Au⁰. Since the Au^I will only be created in the vicinity of the laser exposure, the laser will be able to direct or trace where the electrode will grow. The combination of photo-redox and applied potentials has recently been demonstrated as an effective gold film etching technique [33]. In this work, we seek to prove the potential of μ PLATE as an additive technique, which, once optimized, is expected to require a smaller quantity of gold compared to similar subtractive techniques.

Figure 1 illustrates how μ PLATE works. A seed electrode is placed in a solution containing $Au^{III}Br_4^-$ and ethanol with a potential applied that is too positive to cause reduction of the $Au^{III}Br_4^-$. A laser is tightly focused through an objective lens into the sample, close in proximity to the gold seed electrode, allowing for the localized photoreduction of $Au^{III}Br_4^-$ to $Au^IBr_2^-$. While the $Au^{III}Br_4^-$ absorbs the laser and is photoreduced, the resulting $Au^IBr_2^-$ is transparent at 405 nm and cannot undergo further photoreduction to Au^0 . The potential of the electrode can selectively reduce $Au^IBr_2^-$, thus electroplating Au^0 onto the seed electrode. The standard

reduction potentials for Au^{III}Br₄⁻ and Au^IBr₂⁻ vs SHE are shown below [34].

$$Au^{III}Br_4^- + 3e^- \rightarrow Au^0 + 4Br^- (E^\circ + 0.960 \text{ V})$$
 (1)

$$Au^{I}Br_{2}^{-} + 1e^{-} \rightarrow Au^{0} + 2Br^{-}(E^{\circ} + 0.858 \text{ V}).$$
 (2)

These indicate that there should exist a potential window to enable the selective deposition of only Au^IBr₂⁻.

In this work, both the electrochemical and photochemical aspects of the μ PLATE method were examined. The kinetics of the photochemical reduction of $Au^{III}Br_4^-$ were studied using a homemade laser photometer system and a rate law was determined. Controlled potential electrolysis (CPE) experiments were used over a range of voltages to identify a potential that enabled the selective deposition of $Au^IBr_2^-$ in the presence of $Au^{III}Br_4^-$. Also, the rate of deposition was studied with a quartz crystal microbalance (QCM) as the ratio of $Au^IBr_2^-$: $Au^{III}Br_4^-$ changed. Finally, results are shown from a proof of concept experiment where gold was locally deposited via the μ PLATE method.

2. Methods and materials

Gold wire, 99.95% pure and 25 μ m in diameter, was purchased from Alfa Aesar. The AuBr₃, 99.9%, (the precursor of Au^{III}Br₄⁻ in the presence of Br⁻) and all other reagents were used as received from Sigma-Aldrich.

2.1. Photoreduction kinetics

A solution containing 0.10 M NaClO₄, 0.10 M HBr, and 0.15 mM $\rm Au^{III}Br_4^-$ was prepared in a solution of ethanol:water::3:1 (v/v). This solution was placed in a 1 cm pathlength cuvette and the absorbance spectra was recorded using a Cary 300 UV–vis spectrophotometer. The instrument was blanked with the same solution excluding the $\rm Au^{III}Br_4^-$. The cuvette was irradiated with a 405 nm laser (Coherent, OBIS)

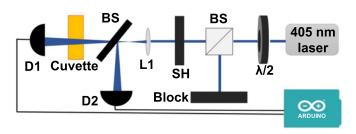


Figure 2. Photometer schematic. From right to left, the laser beam passes through a half-wave plate then through a PBS, a shutter (SH), and is expanded with lens (L1). A second beam splitter (BS) divides the beam. One portion is collected by reference detector, D2, the other passes through a cuvette and the remaining light is collected by detector D1. Data are collected using a customized Arduino system.

with 1.5 mW for 120 min and periodically removed to measure the absorption spectrum.

To determine the rate of the photochemical reduction, a homemade laser photometer was assembled as shown in figure 2. The 405 nm laser was passed through a half-wave plate and a polarizing beam splitter (PBS) to enable the power to be adjusted. Next, the beam was slightly expanded before hitting a 50/50 beam splitter, where a reference detector, D1, (Thorlabs PDA100A) measured any laser fluctuations. The transmitted light completely exposed the 0.1 ml of solution in the cuvette (Thorlabs CV10Q100) before being detected on the second photodiode, D2. The signals from both detectors were measured for 30 s and were sent to an Arduino board (Mega 2560) equipped with a 16 bit analog to digital converter (Adafruit, ADS1115) and a real time clock module where the signal was collected and processed using custom software. For rate law experiments, all glassware, including the cuvette, were rinsed with ethanol and DI water, then dried with Ar (g). Gold solutions were prepared by varying ethanol concentration between 2.56 and 13.7 M (pure ethanol is 17.2 M) and varying the Au^{III}Br₄⁻ concentration between 0.0125 and 1 mM, while maintaining 0.1 M HBr and 0.1 M NaClO₄. All experiments were conducted at room temperature (24 ± 1 °C). The solution's temperature did not change by more than 1 °C during the experiment.

2.2. Electrochemical reduction

For electrochemical experiments, a BASi EC Epsilon potentiostat was used along with a Pt gauze counter electrode and a Ag/AgBr (sat'd KBr) reference electrode. All electrochemical results are referred to using the polarographic rather than the IUPAC sign convention. The reference electrode was placed in a Luggin capillary. CPE experiments were performed using gold wire (25 μ m diameter) as the working electrode, which was submerged \sim 1.0 cm into the solution. For each experiment, a new piece of gold wire was used. The solution used for CPE experiments contained 0.30 mM Au^{III}Br₄ $^-$, 0.10 M NaClO₄, 0.10 M HBr in ethanol:water::1:1 (v/v). This solution was either (a) used as is, or prior to the CPE, (b) exposed to a 405 nm laser at 75 mW for 10 min, or (c) 1.0 mol equivalent of ascorbic acid (AA) was added. Both laser exposure

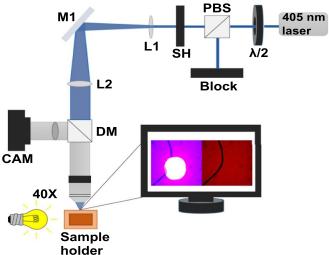


Figure 3. μ PLATE laser schematic. The laser beam passes through a half-wave plate, a PBS, a shutter (SH), is expanded with lens (L1), and columnated with second lens (L2). A dichroic mirror (DM) transmits the laser beam and reflects illumination light from the sample into the camera (CAM). The laser passes through a $40\times$ objective lens and onto the gold wire in the solution.

and AA were used to reduce Au^{III}Br₄⁻ to Au^IBr₂⁻. Following CPE at different voltages, the working electrodes were rinsed, dried, and imaged by a scanning electron microscope (SEM) (Tescan MIRA 3).

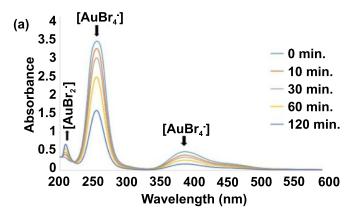
For QCM experiments, the working electrode was a 1.0 cm diameter gold film on a quartz wafer (SRS, QCM 25) which was connected to a QCM200 (SRS). The QCM was calibrated using a solution of 0.05 M AgNO₃ in 0.50 M HNO₃ per the manufacturer's instructions. The gold solution was 50 ml of 3 mM Au^{III}Br₄ $^-$, 0.10 M NaClO₄, 0.10 M HBr in ethanol:water::1:1 (v/v). A solution of 0.015 M AA was added to the gold solution in five 20 μ l aliquots, while a potential of +0.650 V vs Ag/AgBr was applied to the working electrode and the resonant frequency of the QCM was recorded.

To demonstrate the μ PLATE concept, a custom sample holder was 3D printed which contained a slot for a window. The window was a 25 × 25 mm #1 coverslip. As shown in figure 3, a 40 × 0.75 NA objective lens was used to focus the 405 nm laser onto the gold wire which was submerged in the solution containing 13.1 mM ${\rm Au^{III}Br_4}^-$, 0.1 M NaClO₄, 0.1 M HBr in ethanol:water::1:1. The lens in front of the camera was adjusted to be confocal with the laser such that both the image and the laser focused to the same plane. A CH Instruments potentiostat (CHI604E) was used to apply +0.550 V vs Ag/AgBr and a Pt gauze was used as the counter electrode. The potential was applied for 15 min, while the laser was focused onto the wire with 100 mW of power at the sample.

3. Results and discussion

3.1. Photochemical reduction of Au^{III}Br₄-

The first step of the μ PLATE method is the photochemical reduction of $Au^{III}Br_4^-$ to $Au^IBr_2^-$ via 405 nm light. This



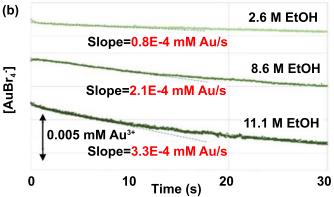


Figure 4. (a) Absorbance spectra of $Au^{III}Br_4^-$ and $Au^IBr_2^-$ over time upon 405 nm laser irradiation. (b) Photokinetics traces of $Au^{III}Br_4^-$ reduction at fixed initial $[Au^{III}Br_4^-] = 0.15$ mM and varied concentrations of ethanol with slopes fit to the first 10 s.

photoreductive elimination was first reported by Vogler and coworkers [35, 36] in ethanol, with the reaction:

$$AuBr_4^- + CH_3CH_2OH \rightarrow AuBr_2^- + CH_3CHO + 2 HBr.$$
 (3)

Figure 4(a) shows the absorption spectra of 0.15 mM Au^{III}Br₄⁻ in ethanol:water::3:1 (v/v) as a function of time during exposure to a 405 nm laser. The 405 nm laser was chosen because it overlaps sufficiently with the Au(III)Br₄⁻ peak centered at 395 nm but is not absorbed by Au(I)Br₂⁻, which has a peak absorbance at 210 nm. As the time of exposure increases, the amount of Au^{III}Br₄⁻ in the solution decreases while the presence of Au^IBr₂⁻ increases, showing the direct relationship between the disappearance of Au^{III}Br₄⁻ and the appearance of Au^IBr₂⁻. Notably, there is no peak present corresponding to the absorption due to colloidal gold (\sim 520 nm), indicating that while 405 nm light will reduce Au^{III}Br₄⁻, there is no further reduction of Au^IBr₂⁻ to colloidal gold [37, 38]. This is important for the μ PLATE technique, as it ensures that the only species present in the electroplating process are $Au^{III}Br_4^-$ and $Au^IBr_2^-$.

To understand the kinetics of this photoreduction better, we used the method of initial rates, varying the concentration of ethanol and $Au^{III}Br_4{}^-$ as well as the power of the laser. The concentration of $Au^{III}Br_4{}^-$ over time is plotted (figure 4(b))

and the slope is equal to the rate of disappearance (mM Au s⁻¹) which is measured during the first 10 s of exposure. Table 1 shows data from nine trials, a subset of the 100+ trials that were used to determine the rate law of the reaction.

To convert the change in absorbance to concentration, the extinction coefficient of $\mathrm{Au^{III}Br_4}^-$ at 405 nm was used. This value was determined from a Beer–Lambert plot to be 3.58 mM⁻¹ cm⁻¹ (data not shown). Over the concentration range tested, the rate constant, k, was determined to be 7 (± 3) \times 10⁻⁶ mM^{2/3} M⁻¹ mW⁻¹, and the rate law is shown in (4):

Rate =
$$k[Au^{III}Br_4^-]^{\frac{1}{3}}[EtOH]^1p^1$$
. (4)

3.2. Electrochemistry of $Au^{III}Br_4^-$ and $Au^IBr_2^-$

The second step of the μ PLATE technique selectively plates $Au^IBr_2^-$ created via irradiation by 405 nm light. This step hinges on $Au^{III}Br_4^-$ plating at a more positive potential than $Au^IBr_2^-$, thus ensuring that only $Au^IBr_2^-$ is deposited onto the surface of the metal. The plating bath consists of NaClO₄, which acts as a supporting electrolyte, $Au^{III}Br_4^-$, which acts as a source of $Au^IBr_2^-$, and HBr, which solubilizes $Au^IBr_2^-$. The ethanol is added to act as a photochemical reducing agent as shown in equation (3).

For these experiments, gold was plated onto a gold wire. The gold wire was selected because of its convenience of preparation, both for the μ PLATE procedure and because it can be easily imaged by optical and electron microscopy. Materials besides gold can be used, but may require an overpotential to initiate deposition, which could change as the surface becomes coated. For this proof of principle work we wanted to maintain a constant applied potential throughout the entire deposition and so chose to deposit gold on gold.

Figure 5 shows a series of SEM images of gold wires in which electrodeposition by CPE was attempted under varying conditions. In the left column, the wires were placed in a solution that contained only Au^{III}Br₄⁻. In the middle column, the wires were placed in a solution of Au^{III}Br₄⁻ that had been exposed to a 405 nm laser to generate Au^IBr₂⁻, resulting in a mixture of both AuIBr₂- and AuIIIBr₄-. In the right column, AA was added to a solution of Au^{III}Br₄⁻ to convert all Au^{III}Br₄⁻ to Au^IBr₂⁻ [39]. The AA was used as a control as a means of chemically generating Au^IBr₂⁻ independent of photoreduction to test the selectivity of electrodeposition. All sets of wires were held at varying potentials for 10 min and then imaged by a SEM. The images show there exists a voltage threshold near +0.500 V, (vs Ag/AgBr) above which the Au^{III}Br₄⁻ does not reduce; however, at this same voltage and even at +0.600 V Au^IBr₂⁻ readily plates. In the solution containing a mixture of Au^{III}Br₄⁻ and photoreduced $Au^{I}Br_{2}^{-}$, some deposition can be seen at +0.500 V and less so at +0.600 V. From these results we conclude that Au^IBr₂⁻ can be selectively deposited from a mixture of Au^IBr₂⁻ and Au^{III}Br₄⁻.

We also performed CPE experiments with a QCM to gain a better understanding of the kinetics of the selective 0.15

0.15

0.15

0.15

[Au] (mM)	[EtOH] (M)	Power (mW)	Rate $(10^{-4} \text{ mM Au s}^{-1})$	Rate constant, k (10 ⁻⁵ mm ^{2/3} M ⁻¹ mW ⁻¹)
0.05	8.6	8.0	1.5	6.1
0.30	8.6	8.0	3.0	6.6
1.00	8.6	8.0	4.2	6.1
0.15	2.6	8.0	0.8	7.4
0.15	8.6	8.0	2.1	5.8

3.3

0.8

1.2

3.3

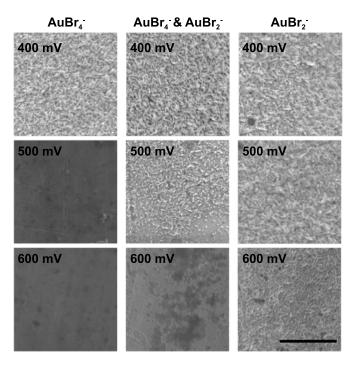
8.0

2.0

4.0

6.0

Table 1. Kinetics data from nine trials of over 100 trials.



11.1

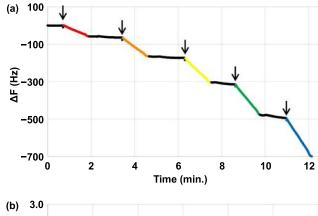
8.6

8.6

8.6

Figure 5. SEM images of electrodeposition in a potential window of +0.400–0.600 V (vs Ag/AgBr) on gold wires from solutions of Au^{III}Br₄ $^-$ (left column), a photoreduced mixture of Au^{III}Br₄ $^-$ and Au^IBr₂ $^-$ (middle column), and Au^IBr₂ $^-$ (right column). The left column shows electrodeposition of Au^{III}Br₄ $^-$ at +0.400 V only, the middle column shows electrodeposition of Au^{II}Br₂ $^-$ at +0.400 and +0.500 V, and a small amount at +0.600 V, and the right column shows electrodeposition of Au^IBr₂ $^-$ at +0.400, +0.500, and +0.600 V. Scale bar is 5 μ m.

electrodeposition of $\mathrm{Au^{II}Br_2}^-$ and $\mathrm{Au^{III}Br_4}^-$. For this experiment, a calibrated gold QCM electrode was placed in a solution containing 0.15 mmol of $\mathrm{Au^{III}Br_4}^-$. Next, 200 μ l of 0.15 M AA was titrated into the $\mathrm{Au^{III}Br_4}^-$ solution and a CPE experiment was performed, holding the voltage at +0.650 V (vs Ag/AgBr) while monitoring the QCM resonant frequency. As shown in figure 6(a) the decreasing frequency corresponds to the electrodeposition of $\mathrm{Au^IBr_2}^-$. After 1 min the applied voltage was turned off and the QCM was allowed to stabilize for \sim 1 min before the process was repeated.

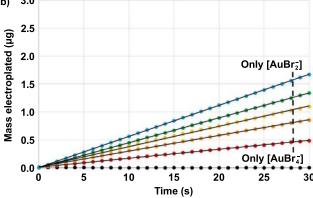


6.9

8.4

6.5

5.8



•0.0 mol eq •0.2 mol eq •0.4 mol eq •0.6 mol eq •0.8 mol eq •1.0 mol eq

Figure 6. QCM electrodeposition in a solution containing $Au^{III}Br_4^-$ as it is converted to $Au^IBr_2^-$. (a) The change in resonance frequency was measured by the QCM during the titration with the arrows indicating when additions of AA occurred. (b) The additional mass of gold deposited in the first 30 s after each injection of AA is shown.

Five additions of AA were performed which converted all $Au^{III}Br_4^-$ to $Au^IBr_2^-$. The figure 6(a) shows the QCM trace over the course of the experiment, with arrows indicating when the AA was added. The QCM data for the first 30 s following each addition are replotted in figure 6(b) after converting the change in resonance frequency to mass. The slopes of the QCM data increase with more AA, indicating that higher concentrations of $Au^IBr_2^-$ result in higher rates of plating.

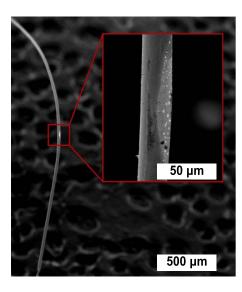


Figure 7. SEM images showing selective deposition of $\mathrm{Au^IBr_2}^-$ onto the gold wire electrode which was held at a potential of +0.550 V while being exposed to a 405 nm laser.

These data further substantiate that, within the potential window, $Au^IBr_2^-$ will selectively plate in a solution where both $Au^{II}Br_4^-$ and $Au^IBr_2^-$ are present.

3.3. Application of µPLATE

A proof of principle experiment was performed using the experimental setup shown in figure 3. A gold wire was placed in a solution of Au^{III}Br₄⁻, and it was exposed to a focused laser while a potential of +0.550 V (vs Ag/AgBr) was applied. This potential does not reduce Au^{III}Br₄⁻ but can selectively reduce Au^IBr₂⁻. Following the 15 min exposure, the sample was rinsed and imaged by a SEM. Figure 7 shows that gold was locally deposited at a spot on the wire over an approximately 100 μ m long patch. The deposited gold is on the order of 1 μ m thick and has granular flakes, similar to those shown in figure 5, with grain sizes of \sim 100 nm. We believe the deposition took place by the two steps involved in μ PLATE because during the exposure we did not see any evidence of a photothermal process taking place. That is, no bubbles or convective currents were observed near the focal point of the laser, which agrees with the kinetics trials where the temperature was observed to have not changed during the laser exposure.

Using the rate law equation (4), the electron micrograph in figure 7, and the CPE data, we can estimate the overall efficiency of the μ PLATE process and its rate-limiting step. The amount of gold deposited in figure 7 is $\sim 1000~\mu\text{m}^3$ (100 \times 10 \times 1 μ m), which corresponds to ~ 0.1 nmoles of gold. The rate law equation applied over the focal cone of light in the sample is estimated to generate $\sim 15~\mu\text{M s}^{-1}$ of $\text{Au}^{\text{I}}\text{Br}_2^{-}$, which totals ~ 0.1 nmoles over a 15 min period. Thus it would seem that the amount of $\text{Au}^{\text{I}}\text{Br}_2^{-}$ generated is approximately equal to the amount of Au^{O} plated. Therefore, the efficiency of the μ PLATE process, to a zeroth order approximation, is >10%. Given that the amount of gold electrodeposited is comparable to the amount estimated to have

been photoreduced, we believe the rate limiting step is the first step, which is the photoreduction of $\mathrm{Au^{III}Br_4}^{-}$. The CPE data for the second step, which is electrodeposition, indicate a higher rate of electrodeposition compared to photoreduction, but we believe a significant fraction of this current is non-Faradaic, since it is not possible to deposit $\mathrm{Au^IBr_2}^-$ faster than it is created. It is hard to know exactly what the Faradaic current due solely to electrodeposition is, but the total CPE current implies that it is at least as fast as the rate-limiting photoreduction step.

While the μ PLATE method has been demonstrated as we hypothesized, further optimization is necessary. The diffraction limited laser focal spot should be \sim 0.5 μ m in diameter but the deposition area is significantly larger. We believe this is because the locally generated ${\rm Au^IBr_2}^-$ is free to diffuse in the solution before being plated. Also, the rate of deposition is likely made slower by this diffusion process.

4. Conclusion

In conclusion, the μ PLATE method is a novel approach for localized gold deposition. Within a potential window of +0.500 to +0.650 V (vs Ag/AgBr), Au^IBr₂⁻ produced by photoreduction of Au^{III}Br₄⁻ is selectively deposited onto a gold working electrode, resulting in localized plating. Although more work needs to be done to improve the speed and resolution of the μ PLATE technique, we have shown that gold can be locally photoreduced and electroplated in a hybrid DLW-electrochemical patterning method.

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